

BF244A BF244B BF244C



N-Channel RF Amplifier

This device is designed for RF amplifier and mixer applications operating up to 450 MHz, and for analog switching requiring low capacitance. Sourced from Process 50.

Absolute Maximum Ratings* TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V_{DG}	Drain-Gate Voltage	30	V	
V _{GS}	Gate-Source Voltage	- 30	V	
I _D	Drain Current	50	mA	
I _{GF}	Forward Gate Current	10	mA	
T _{stg}	Storage Temperature Range	-55 to +150	°C	

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1) These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics TA = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units	
		BF244A / BF244B / BF244C		
P_D	Total Device Dissipation	350	mW	
	Derate above 25°C	2.8	mW/°C	
$R_{\theta JC}$	Thermal Resistance, Junction to Case	125	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W	

Тур

Min

(continued)

Units

Max

Electri	cal Characteristics	TA = 25°C unless otherwise noted			
Symbol	Parameter		Test Condi		

OFF CHARACTERISTICS							
V _{(BR)GSS}	Gate-Source Breakdown Voltage	$I_G = 1.0 \mu\text{A}, V_{DS} = 0$		30			V
I _{GSS}	Gate Reverse Current	$V_{GS} = -20 \text{ V}, V_{DS} = 0$				5.0	nA
V _{GSS(off)}	Gate-Source Cutoff Voltage	$V_{DS} = 15 \text{ V}, I_{D} = 10 \text{ nA}$		- 0.5		- 8.0	V
V _{GS}	Gate-Source Voltage	$V_{DS} = 15 \text{ V}, I_{D} = 200 \mu\text{A}$	244A	- 0.4		- 2.2	V
			244B	- 1.6		- 3.8	V
			244C	- 3.2		- 7.5	V

Test Conditions

ON CHARACTERISTICS

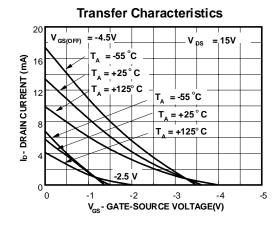
Symbol

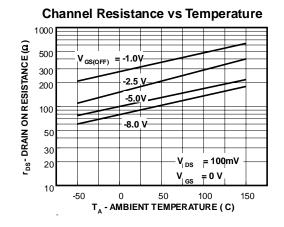
I _{DSS}	Zero-Gate Voltage Drain Current	$V_{DS} = 15 \text{ V}, V_{GS} = 0$	244A	2.0	6.5	mA
			244B	6.0	15	mΑ
			244C	12	25	mA

SMALL SIGNAL CHARACTERISTICS

y fs	Forward Transfer Admittance	$V_{DS} = 15 \text{ V}, V_{GS} = 0, f = 1.0 \text{ kHz}$ $V_{DS} = 15 \text{ V}, V_{GS} = 0, f = 200 \text{ MHz}$	3.0	5.6	6.5	mmhos mmhos
yos	Output Admittance	V _{DS} = 15 V, V _{GS} = 0, f = 1.0 kHz		40		μmhos
yrs	Reverse Transfer Admittance	$V_{DS} = 15 \text{ V}, V_{GS} = 0, f = 200 \text{ MHz}$		1.0		μmhos
Ciss	Input Capacitance	V _{DS} = 20 V, V _{GS} = - 1.0 V		3.0		pF
C _{rss}	Reverse Transfer Capacitance	$V_{DS} = 20 \text{ V}, V_{GS} = -1.0 \text{ V},$ f = 1.0 MHz		0.7		pF
Coss	Output Capacitance	$V_{DS} = 20 \text{ V}, V_{GS} = -1.0 \text{ V},$ f = 1.0 MHz		0.9		pF
NF	Noise Figure	$V_{DS} = 15 \text{ V}, V_{GS} = 0, R_G = 1.0 \text{ k}\Omega,$ f = 100 MHz		1.5		dB
F(Y _{fs})	Cut-Off Frequency	V _{DS} = 15 V, V _{GS} = 0		700		MHz

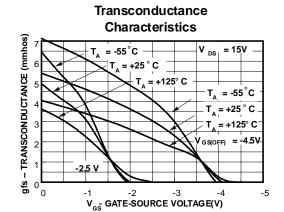
Typical Characteristics

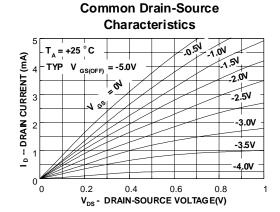


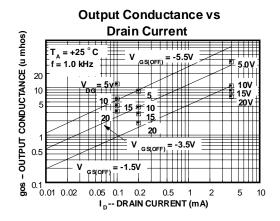


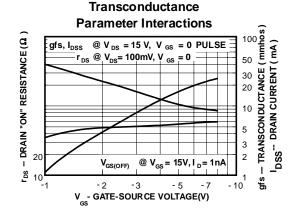
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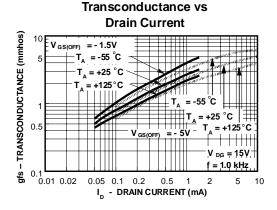
Typical Characteristics (continued)

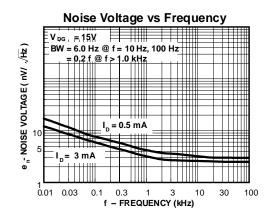






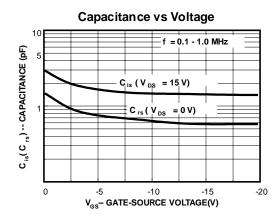


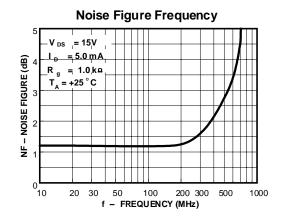




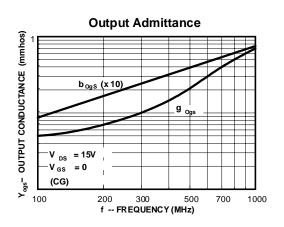
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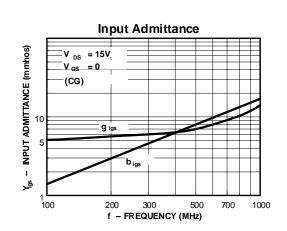
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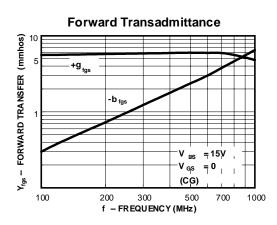


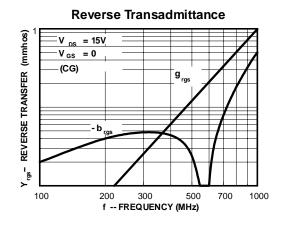


Common Gate Characteristics



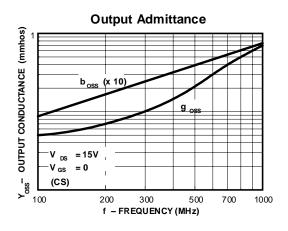


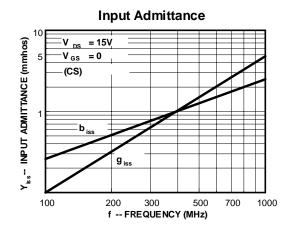


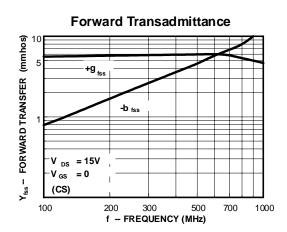


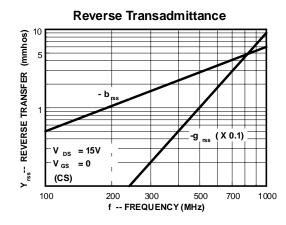
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Common Source Characteristics









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